





IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

Diane C. Boyd et al.

Docket:

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Serial No.:

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Examiner:

Patricia Ann George

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ULTRA-THIN SI MOSFET

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DEVICE STRUCTURE AND

Confirmation No:

3237

METHOD OF

MANUFACTURE

Mail Stop AF Commissioner for Patents United States Patent Office Alexandria, VA 23313-1450

RESPONSE UNDER 37 C.F.R. §1.116

Sir:

In response to the Office Action dated March 22, 2006, applicants submit the following amendments and remarks for entry of record in the above-identified patent application..

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner For Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on May 19, 2006.

Dated: May 19, 2006

Leslie S. Szivos, Ph.D.